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Part Number:	<u>0430451623</u>		\sim
Status:	Active		
Overview	microfit <u>30</u>		
Overview:			
Description:		Micro-Fit 3.0 [™] Header, Surface Mount Compatible, Dual Row, s-fit Metal Retention Clip, 16 Circuits, 0.76µm (30µ") Gold (Au)	
	Selective Plating, Glov		
	Selective Flating, Glo		
Documents:		Deschust On a sification DO 40045 (DDE)	
<u>3D Model</u>	Product Specification PS-43045 (PDF) RoHS Certificate of Compliance (PDF)		Series
Drawing (PDF)		ROHS Certificate of Compliance (PDF)	image - Reference only
Agency Certifica	tion		
CSA		LR19980	EU RoHS China RoHS
TUV		R72081037	ELV and RoHS
UL		E29179	Compliant
UL		E29179	REACH SVHC
General			Contains SVHC: No
Product Family		PCB Headers	Halogen-Free
Series		43045	Status
Application		Wire-to-Board	Halogen-Free
Comments		High Temperature Square Pin Solder Type	Need more information on product
Overview		microfit 30	environmental compliance?
Product Literature Or	der No	USA-106	
Product Name		Micro-Fit 3.0™	Email productcompliance@molex.com
			For a multiple part number RoHS Certificate of
Physical			Compliance, <u>click here</u>
Breakaway		No	Please visit the Contact Us section for any
Circuits (Loaded)		16	non-product compliance questions.
Circuits (maximum)		16	
Color - Resin	1	Black	,
Durability (mating cyc	cies max)	30	
Flammability Glow-Wire Compliant		94V-0 Yes	Search Parts in this Series
	l	0.396 ln	43045Series
Mated Height (in) Mated Height (mm)		10.06 mm	
Material - Metal		Brass	Mates With
Material - Plating Mat	tina	Gold	43025
Material - Plating Ter		Tin	TOVEN
Material - Resin		High Temperature Thermoplastic	
Number of Rows		2	
Orientation		– Right Angle	
PCB Locator		Yes	
PCB Retention		Yes	
PCB Thickness Reco	ommended (in)	0.062 In	
PCB Thickness Reco		1.60 mm	
Packaging Type	· ·	Tray	
Pitch - Mating Interfa	ce (in)	0.118 ln	
Pitch - Mating Interface	ce (mm)	3.00 mm	
Plating min: Mating (uin)	30	
Plating min: Mating (um)	0.76	
Plating min: Terminat		100	
Plating min: Terminat	tion (µm)	2.50	
Polarized to PCB		Yes	
Shrouded		Fully	
Stackable		No	
Surface Mount Comp	atible (SMC)	Yes	

Temperature Range - Operating Termination Interface: Style	-40℃ to +105℃ Through Hole
Electrical Current - Maximum per Contact Voltage - Maximum	5A 250V
Solder Process Data Duration at Max. Process Temperature (seconds) Lead-free Process Capability Max. Cycles at Max. Process Temperature Process Temperature max. C	30 SMC & Wave Capable (TH only) 3 260
Material Info	
Reference - Drawing Numbers Packaging Specification Product Specification Sales Drawing	PK-70873-0313 PS-43045, RPS-43045-003, RPS- SD-43045-008

RPS-43045-004 SD-43045-008 TS-43045-001, TS-43045-002

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Test Summary

